

3.0A SURFACE MOUNT FAST RECOVERY RECTIFIER

Features

- Glass Passivated Die Construction
- Fast Recovery Time for High Efficiency
- Surge Overload Rating to 100A Peak
- Ideally Suited for Automatic Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMB, SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish).
 Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: SMB 0.093 grams (approximate)
 SMC 0.21 grams (approximate)





Top View

Bottom View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	RS3 A/AB	RS3 B/BB	RS3 D/DB	RS3 G/GB	RS3 J/JB	RS3 K/KB	RS3 M/MB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 6)	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_T = 75^{\circ}C$	I _O		=	•	3.0	=	=	•	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}				100				Α

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Typical Thermal Resistance Junction to Terminal (Note 3)	SMB SMC	$R_{ heta JT}$	25 11	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	RS3 A/AB	RS3 B/BB	RS3 D/DB	RS3 G/GB	RS3 J/JB	RS3 K/KB	RS3 M/MB	Unit
Forward Voltage	@ $I_F = 3.0A$	V_{FM}			•	1.3				V
Peak Reverse Current at Rated DC Blocking Voltage (Note 6)	@ T _A = 25°C @ T _A = 125°C	I _{RM}				5.0 250				μА
Maximum Recovery Time (Note 5)		t _{rr}		15	50		250	50	00	ns
Typical Total Capacitance (Note 4)		C _T				50				pF

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/quality/lead_free.html.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
- 4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 5. Reverse recovery test conditions: $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See Figure 5.
- 6. Short duration pulse test used to minimize self-heating effect.



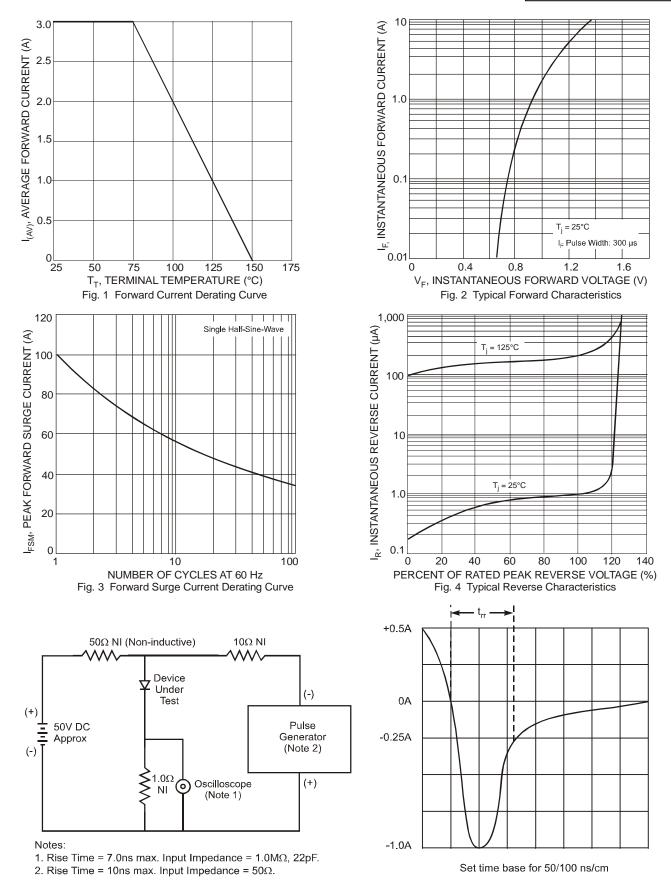


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



Ordering Information (Note 7)

Part Number	Case	Packaging
RS3x-13-F	SMC	3000/Tape & Reel
RS3xB-13-F	SMB	3000/Tape & Reel

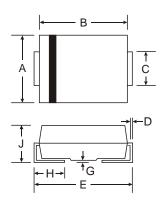
^{*} x = Device type, e.g. RS3A-13-F (SMC package); RS3AB-13-F (SMB package).

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



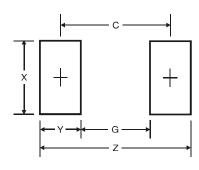
Package Outline Dimensions



SMB					
Dim	Min	Max			
Α	3.30	3.94			
В	4.06	4.57			
С	1.96	2.21			
D	0.15	0.31			
Е	5.00	5.59			
G	0.05	0.20			
Н	0.76	1.52			
J	2.00	2.62			
All Dimensions in mm					

SMC						
Dim	Min	Max				
Α	5.59	6.22				
В	6.60	7.11				
C	2.75	3.18				
D	0.15	0.31				
Е	7.75	8.13				
G	0.10	0.20				
Н	0.76	1.52				
7	2.00	2.62				
All Dimensions in mm						

Suggested Pad Layout



SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Υ	2.5
С	4.3

SMC Dimensions	Value (in mm)
Z	9.3
G	4.4
Х	3.3
Υ	2.5
С	6.8



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